

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
30V	11mΩ@10V	18A
	17mΩ@4.5V	
-30V	20mΩ@-10V	-16A
	29mΩ@-4.5V	

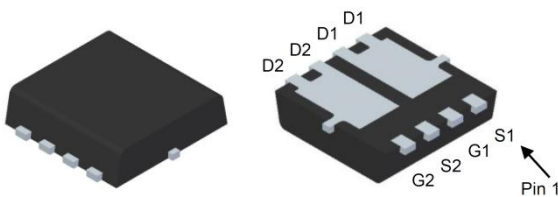
Feature

- TrenchFET Power MOSFET
- Excellent $R_{DS(on)}$ and Low Gate Charge
- Fast Switching Speed

Application

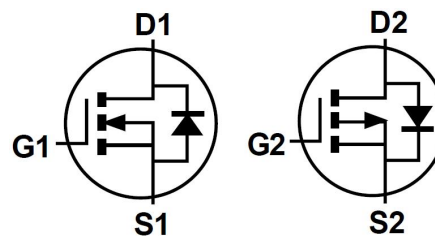
- Motor Control
- Inverters

Package

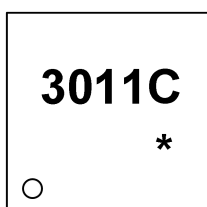


PDFNWB3.3×3.3-8L-B

Circuit diagram



Marking



3011C = Device code
***** = Month Code

Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value		Unit
		N-Channel	P-Channel	
Drain-Source Voltage	V_{DS}	30	-30	V
Gate-Source Voltage	V_{GS}	± 20	± 20	V
Continuous Drain Current(t \leq 10s)	I_D	18	-16	A
Power Dissipation(t \leq 10s)	P_D	22	18	W
Thermal Resistance from Junction to Ambient(t \leq 10s)	$R_{\theta JA}$	5.68	6.94	$^{\circ}C/W$
Junction Temperature	T_J	150		$^{\circ}C$
Storage Temperature	T_{STG}	-55~ +150		$^{\circ}C$

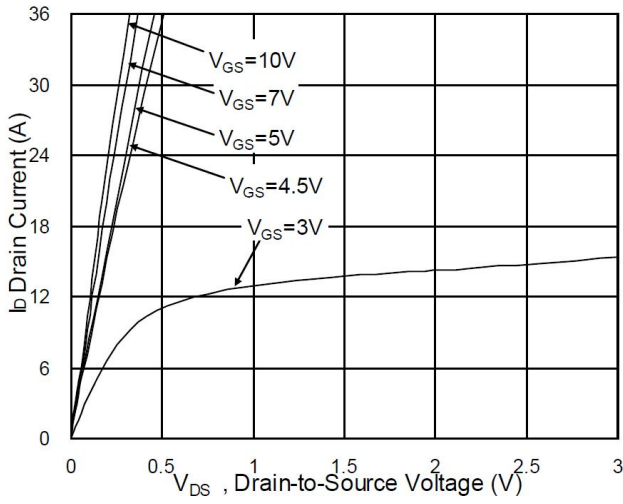
N-Channel Electrical characteristics (T_A=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1	1.5	2.5	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 8A$		11	15	m Ω
		$V_{GS} = 4.5V, I_D = 6A$		17	23	
Dynamic characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$		940		pF
Output Capacitance	C_{oss}			131		
Reverse Transfer Capacitance	C_{rss}			109		
Switching Characteristics						
Total gate charge	Q_g	$V_{DS} = 15V, V_{GS} = 4.5V, I_D = 8A$		9.63		nC
Gate-source charge	Q_{gs}			3.88		
Gate-drain charge	Q_{gd}			3.44		
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 15V, V_{GS} = 10V, RG = 1.5, I_D = 8A$		4.2		ns
Turn-on rise time	t_r			8.2		
Turn-off delay time	$t_{d(off)}$			31		
Turn-off fall time	t_f			4		
Source-Drain Diode Characteristics						
Body Diode Voltage	V_{SD}	$I_S = 1A, V_{GS} = 0V$			1.2	V

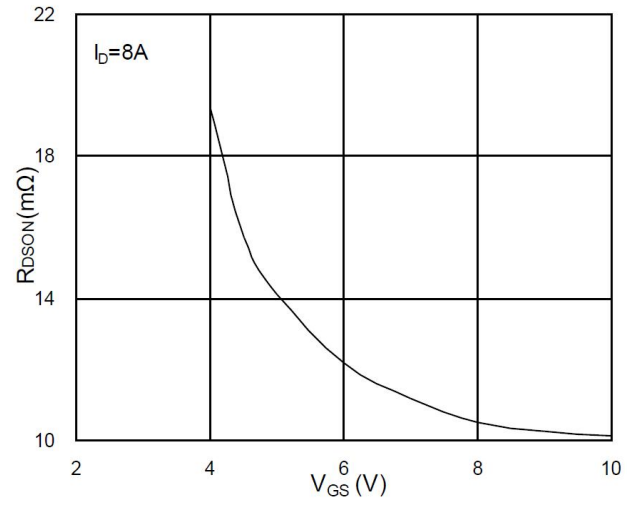
P-Channel Electrical characteristics (T_A=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-30			V
Zero gate voltage drain current	I _{DSS}	V _{DS} = -24V, V _{GS} = 0V			1	μA
Gate-body leakage current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1	-1.5	-2.5	V
Drain-source on-resistance	R _{DS(on)}	V _{GS} = -10V, I _D = -8A		20	24	mΩ
		V _{GS} = -4.5V, I _D = -6A		29	38	
Dynamic characteristics						
Input Capacitance	C _{iss}	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz		1600		pF
Output Capacitance	C _{oss}			350		
Reverse Transfer Capacitance	C _{rss}			300		
Switching Characteristics						
Total gate charge	Q _g	V _{DS} = -15V, V _{GS} = -4.5V, I _D = -8A		30		nC
Gate-source charge	Q _{gs}			5.5		
Gate-drain charge	Q _{gd}			8		
Turn-on delay time	t _{d(on)}	V _{DD} = -15V, I _D = -1A, V _{GS} = -10V, R _{GEN} = 6Ω		10		ns
Turn-on rise time	t _r			15		
Turn-off delay time	t _{d(off)}			110		
Turn-off fall time	t _f			70		
Source-Drain Diode Characteristics						
Body Diode Voltage	V _{SD}	I _S = -1A, V _{GS} = 0V			-1.2	V

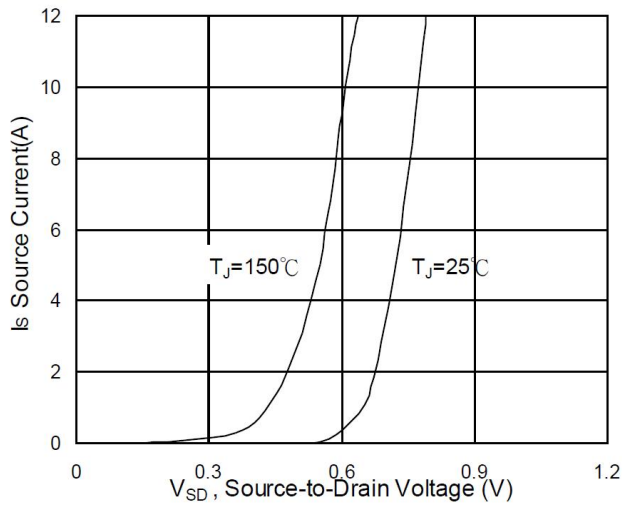
N-Channel Typical Characteristics



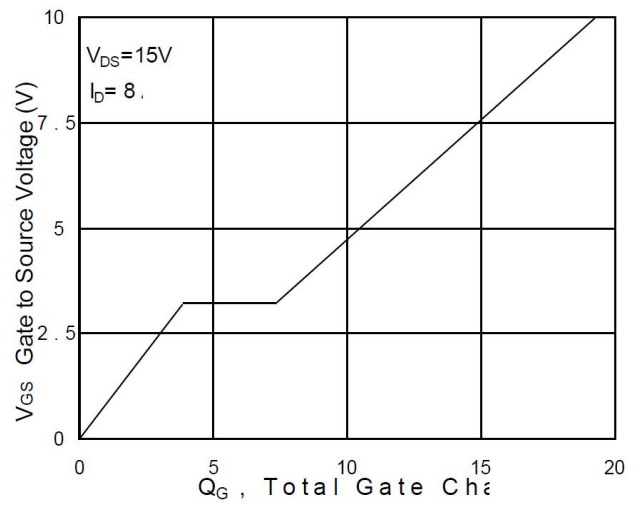
Typical Output Characteristics



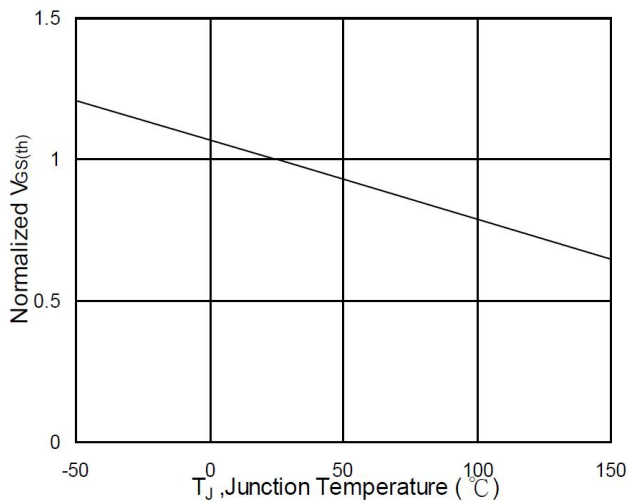
On-Resistance vs. Gate-Source



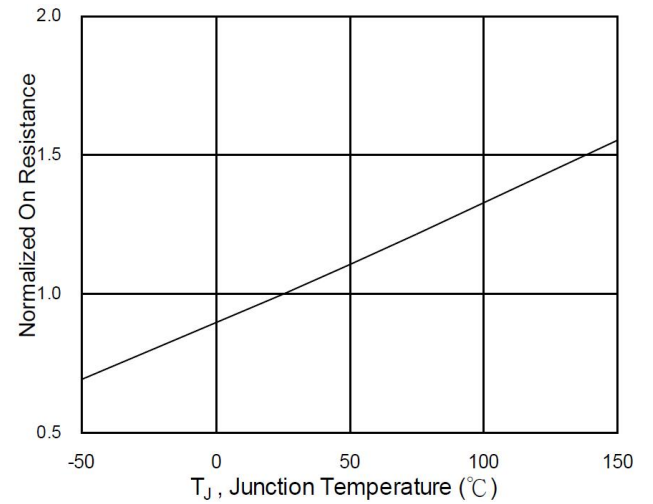
Forward Characteristics Of Reverse



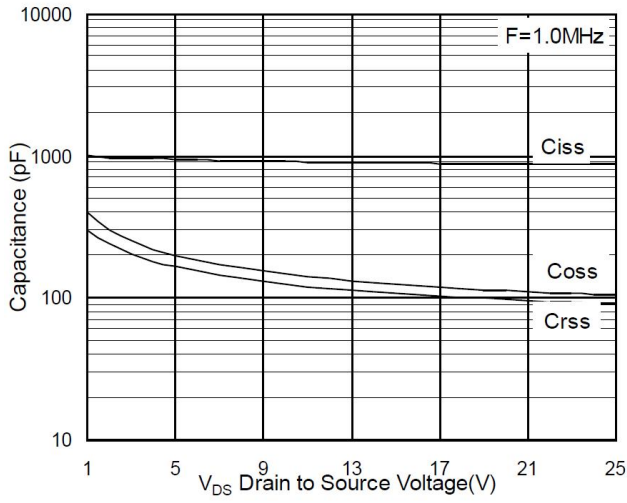
Gate-Charge Characteristics



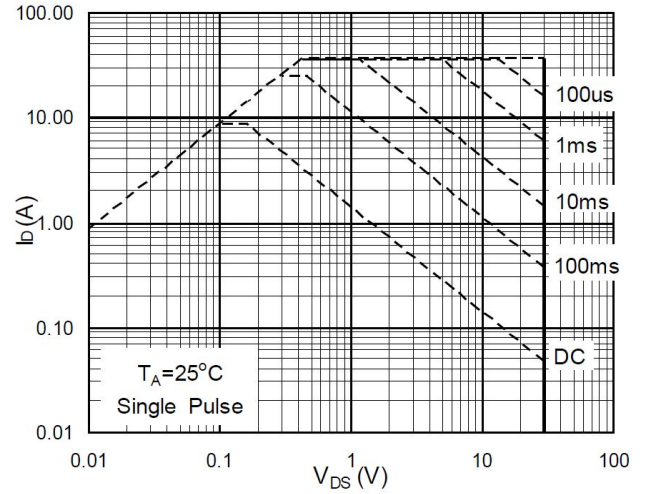
Normalized $V_{GS(th)}$ vs. T_J



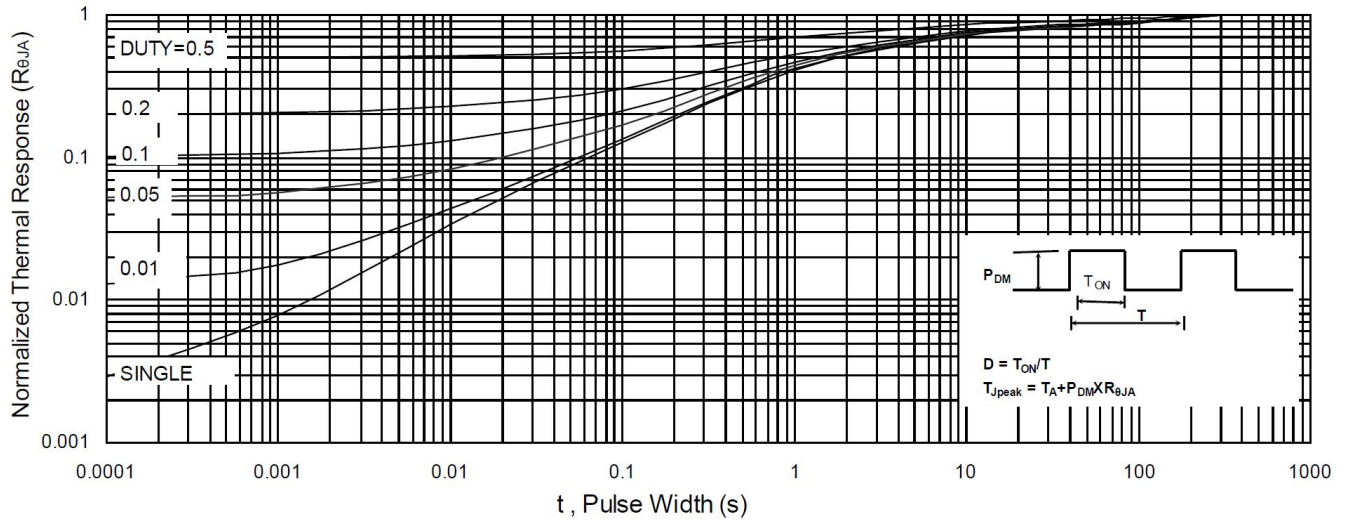
Normalized $R_{DS(on)}$ vs. T_J



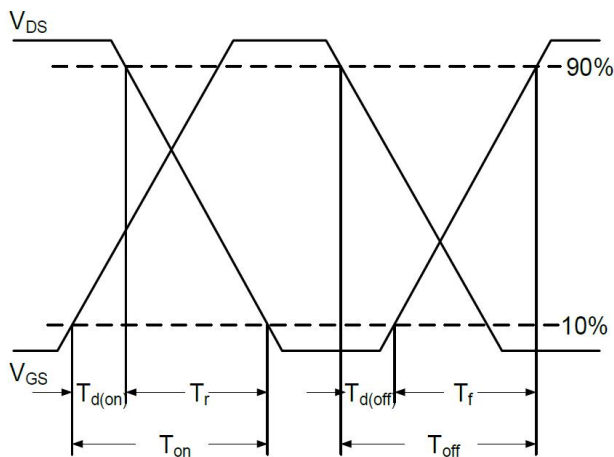
Capacitance



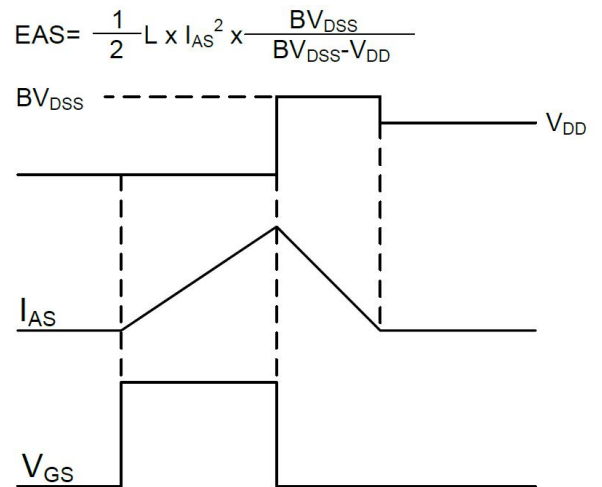
Safe Operating Area



Normalized Maximum Transient Thermal Impedance

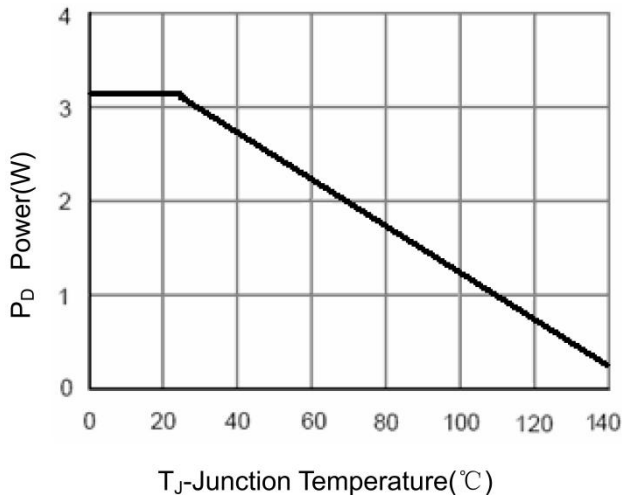


Switching Time Waveform

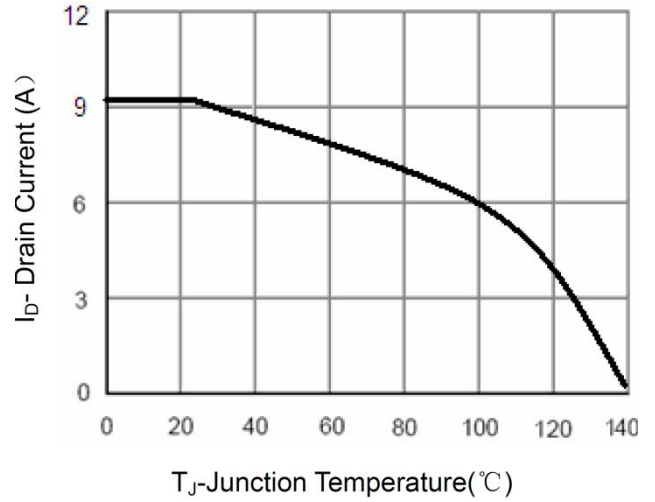


Unclamped Inductive Switching Waveform

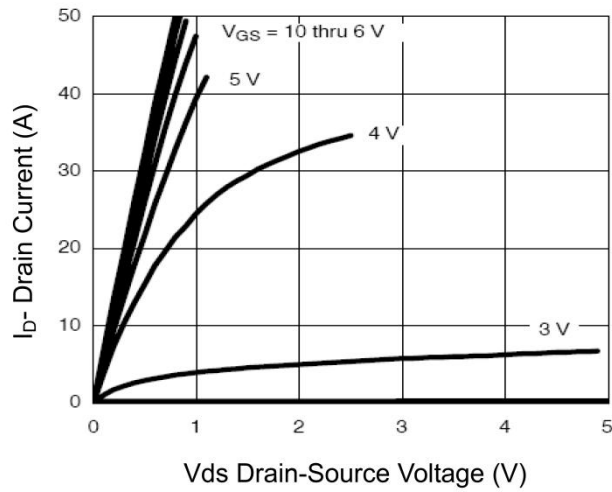
P-Channel Typical Characteristics



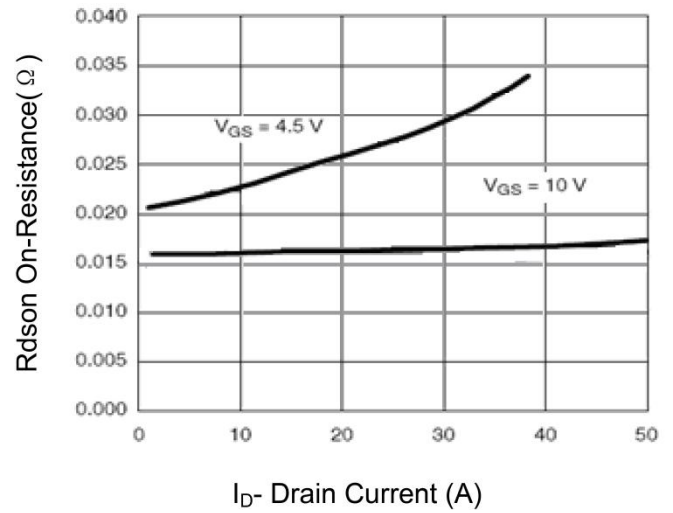
Power Dissipation



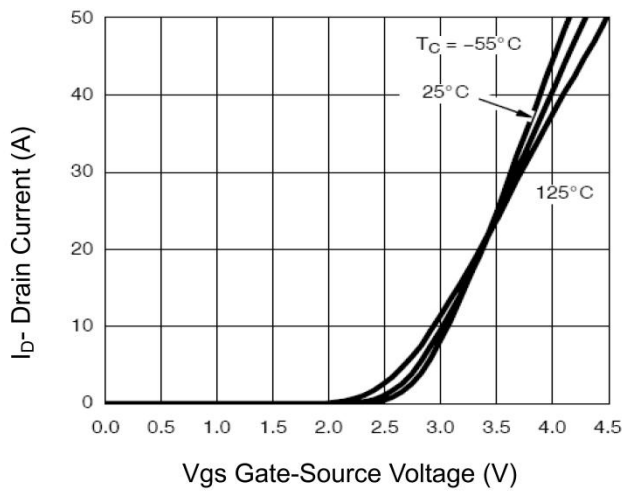
Drain Current



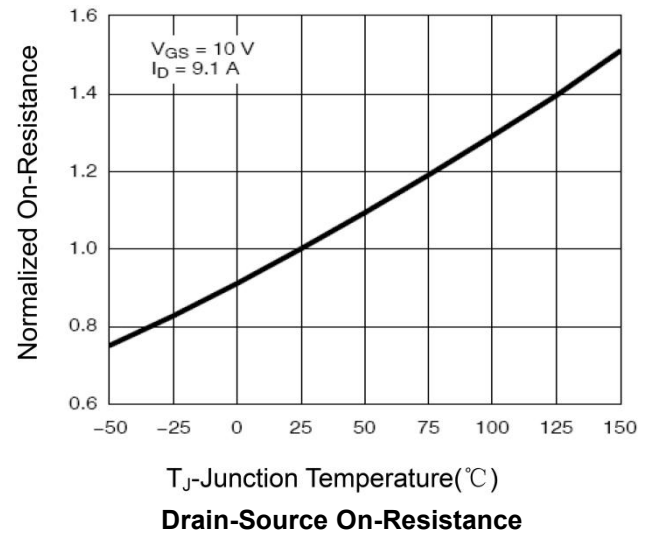
Output Characteristics



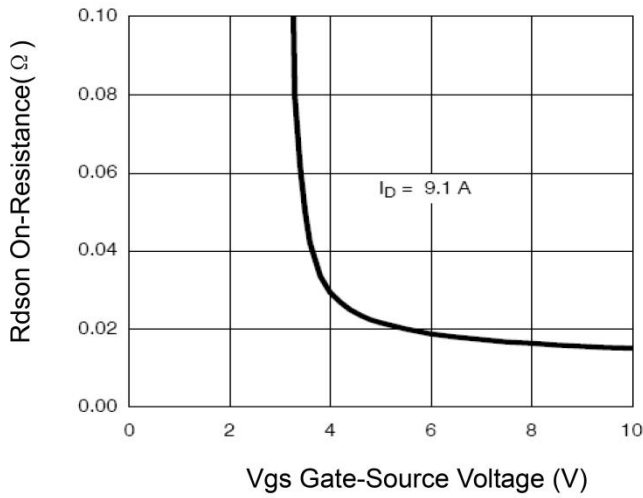
Drain-Source On-Resistance



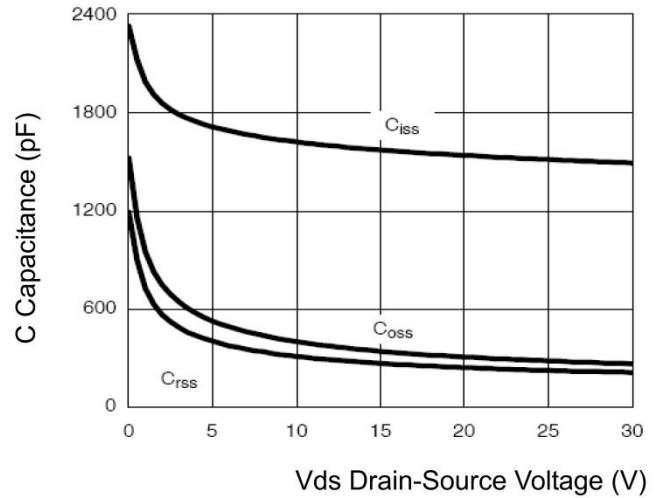
Transfer Characteristics



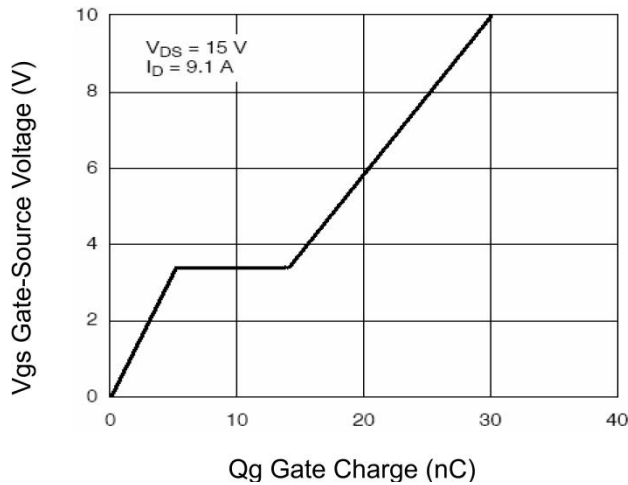
Drain-Source On-Resistance



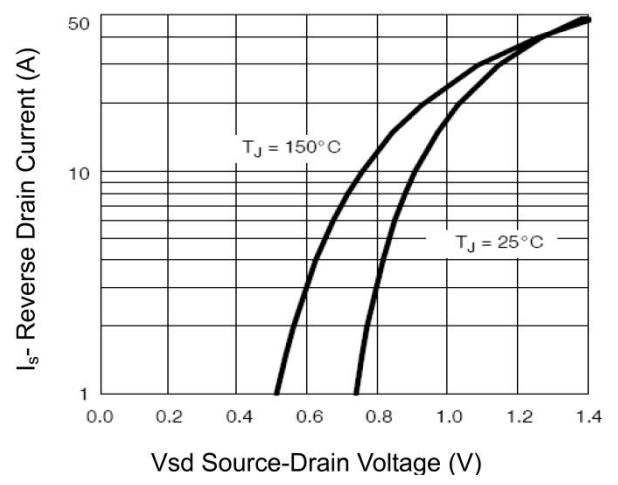
Rdson vs Vgs



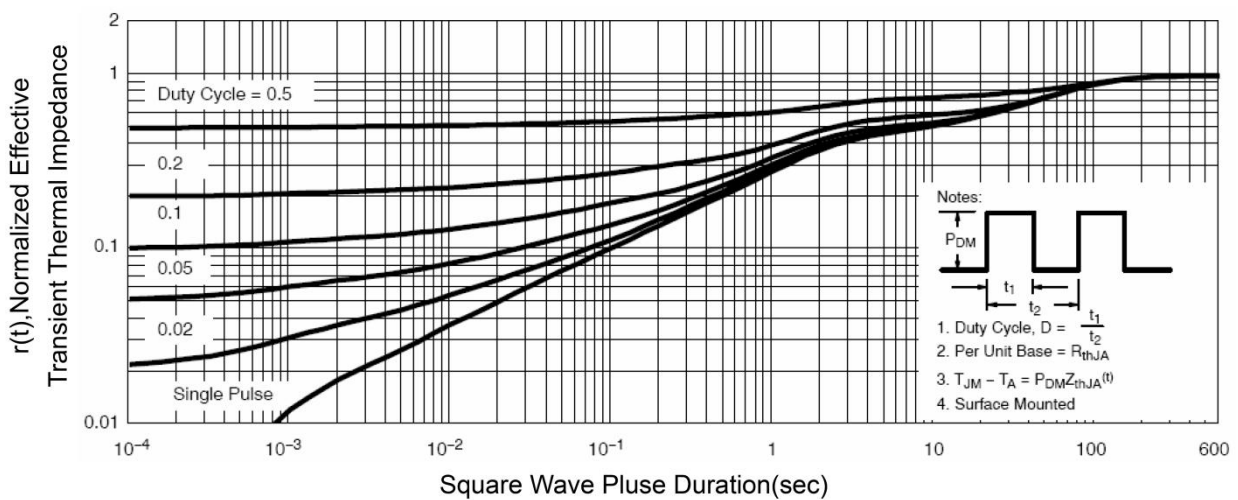
Capacitance vs Vds



Gate Charge



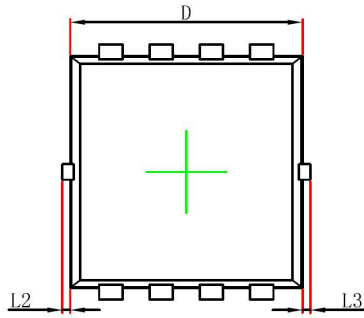
Source- Drain Diode Forward



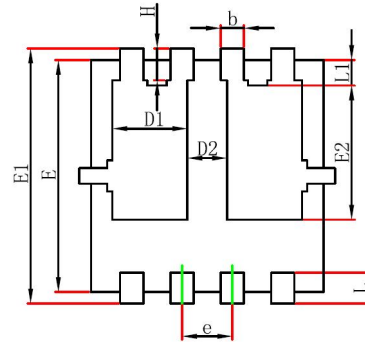
Normalized Maximum Transient Thermal Impedance



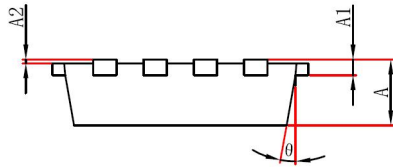
PDFNWB3.3×3.3-8L-B Package Information



Top View
[顶视图]



Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	2.900	3.100	0.114	0.122
D1	0.935	1.135	0.037	0.045
D2	0.280	0.480	0.011	0.019
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°